## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Atty File:

MICT-0050-US (99-0235)

Appli	cant/Patentee: BRAD D. RUMSEY	§ §
Filed	:	99
Seria	I No.:	999
For:	POSITIONING FLOWABLE SOLDER FOR BONDING INTEGRATED CIRCUIT	8

**ELEMENTS** 

## **POWER OF ATTORNEY BY ASSIGNEE**

Under the provisions of 37 C.F.R. § 3.71, the undersigned assignee of record of the entire interest in the above-identified patent/patent application by virtue of an assignment recorded (check as applicable):

$\boxtimes$	Concurrently Herewith				
	<b>Date Recorded</b>				
	Reel	Frame			

elects to conduct the prosecution of the application/maintenance of the patent to the exclusion of the inventor(s). The undersigned hereby declares that he has reviewed the above-referenced assignment and hereby declares that, to the best of his knowledge, title is in the Assignee, and further declares that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true. The assignee hereby revokes any previous powers of attorney and appoints the following to prosecute this application/maintain this patent and transact all business in the Patent and Trademark Office connected therewith:

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SERIAL NUMBER		FILING DATE	CLASS '	GROUP ART UNIT	ATTORNEY DO	OCKET NO.		
09/377,28	36	08/18/99	<del>-228-</del> 174	1725 2841	MICT-00	50 <b>-us</b>		
BRAD D RUMS	EEY, MERIDI	AN, ID.						
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**FOREIGN A VERIFIED	PPLICATION	S*******				NOV 18 1999		
_ KC								
IF REQUIRED, FOREIGN FILING LICENSE GRANTED 09/01/99								
Foreign Priority claims 35 USC 119 (a-d) col Verified and Acknowl	. V A	, `	ID	OR SHEETS DRAWING 2	TOTAL CLAIMS 30	INDEPENDENT CLAIMS 4		
1.46	R HU & MIL FREEWAY SU 77024							
POSITIONING FLOWABLE SOLDER FOR BONDING INTEGRATED CIRCUIT ELEMENTS								
FILING FEE RECEIVED \$1,018	No	ority has been giv _ to charge/credit for the	DEPOSIT ACCO	UNI 🔲 1.17 F	Fees (Filing) Fees (Processing Fees (Issue)	j Éxt. of time)		

The undersigned is authorized to sign this statement on behalf of the Assignee.

Please direct all communications to: <u>TROP, PRUNER, HU & MILES, 8554 Katy Freeway, Suite 100, Houston, Texas 77024</u> to the attention of: <u>Timothy N. Trop, telephone number (713) 468-8880.</u>

**ASSIGNEE**MICRON TECHNOLOGY, INC.

Date: 6 17,1999

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